# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3803404

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

#### **CONVEYING PARTY DATA**

Name	Execution Date
SEYFULLAH HALIT OGUZ	03/15/2016
KHALED HELMI EL-MALEH	03/02/2016
SAURABH SENSHARMA	03/10/2016
ARVIND KULATHU RAMACHANDRAN	03/21/2016

## **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number		
Application Number:	14996943		

## **CORRESPONDENCE DATA**

**Fax Number:** (512)327-5575

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 512-327-5515

Email:dwade@tlgiplaw.comCorrespondent Name:TOLER LAW GROUP

Address Line 1: 8500 BLUFFSTONE COVE

Address Line 2: SUITE A201

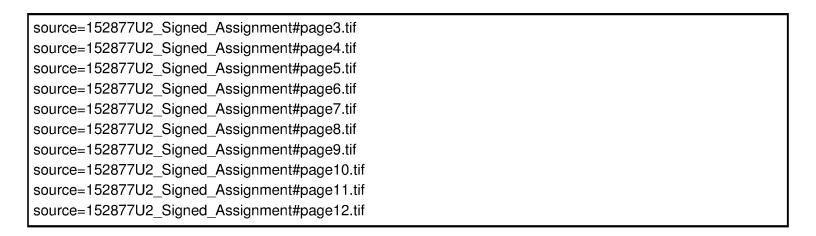
Address Line 4: AUSTIN, TEXAS 78759

ATTORNEY DOCKET NUMBER:	152877U2
NAME OF SUBMITTER:	DAVID WADE
SIGNATURE:	/David Wade/
DATE SIGNED:	03/28/2016

**Total Attachments: 12** 

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PATENT 503756758 REEL: 038115 FRAME: 0378



WHEREAS, WE,

- 1. **Seyfullah Halit OGUZ**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,
- 2. **Khaled Helmi EL-MALEH,** a citizen of Canada, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Marcos, CA,
- 3. **Saurabh SENSHARMA**, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of Hyderabad, IN,
- 4. **Arvind KULATHU RAMACHANDRAN**, a citizen of India, having a mailing address located at 303, Raghuram Heights Opposite SMR Vinay Acropolis, Whitefields, Hyderabad, AP, 500084, India, and a resident of Hyderabad, IN,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **USER INTERFACE FOR A MOBILE DEVICE** (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/996,943 filed January 15, 2016, Qualcomm Reference No. 152877U2, and all provisional applications relating thereto (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at S	an Digo	on 3/	15/2016	444
	LOCATION		DATE	Seyfullah Halit OGUZ
Done at	LOCATION	, on	DATE	Khaled Helmi EL-MALEH
Done at	LOCATION	_, on	DATE	Saurabh SENSHARMA
Done at	LOCATION	, on	DATE	Arvind KULATHU RAMACHANDRAN

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Done at	San Di efec LOCATION	, on	2 no friensk	2016	wh	uuninee,
	LOCATION		DATE		Khaled Helmi EL-MALEH	
Done at		_, on		<u>.</u>		a signisha ayayin
	LOCATION		DATE		Saurabh SENSHARMA	
Done at		_, on				
	LOCATION		DATE	Arv	ind KULATHU RAMACHANDRA	N

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Done at _	LOCATION	, en	DATE	Seyfullah Halit OGUZ
Done at _	LOCATION			
	LOCATION		DATE	Khaled Helmi EL-MALEH
Done at 4	HYDERABAD	, on loth	March, 2016 DATE	Jan som ,
· <del></del> -	LOCATION		DATE	Saurabh SENSHARMA
Done at _	COS CONST	, on		Arvind KULATHU RAMACHANDRAN
	ECCATION		DATE	Arvind KULATHU RAMACHANDRAN

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PATENT QUALCUMUREL No. 152877U2 Page 3 of 3

	AND WE HEREBY ver conflicting with th		ill not exceene any writing or do any act
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Done at	LOCATION OF	DATE	Saurabh SENSHARMA
Done at	Pittsburgh, or	, 03/21/16	2

PATENT REEL: 038115 FRAME: 0391

**RECORDED: 03/28/2016**